

ZSW

55. JAHRGANG 2002



Rate card 2002





Zucker- und Süßwaren Wirtschaft

EDITORIAL FOCUS

ZWS – Zucker- und Süßwaren-Wirtschaft (International Review for the Chocolate, Confectionery and Bakery Industry) is the international trade journal around production and machinery, products and technology of cocoa and chocolate, confectionery, bakery goods, long-term storage items, snacks and ice cream.

With a special focus on research & development as well as raw materials, wrapping/packing and packaging technology, planning, quality assurance, hygiene and marketing. Also focussing on fairs and exhibitions, international affairs, laws and regulations.

ZSW IN THE WEB

WWW.SWEETCOM.DE

Monthly features: You'll find selected articles of the printed issue plus interesting addresses on www.sweetcom.de

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Shipping instruction „free delivery“

ZSW IN NUMBERS 2000

Total	416 pages = 100 %
Text	304 pages = 73 %
Ads	91 pages = 22 %
Self Ads	21 pages = 5 %

SUBSCRIPTION

10 issues per year + annual-CD
95,- EUR/year
(+ postage fee 17,- EUR)

Bank account for subscription only:

Verlag Eduard F. Beckmann KG
Volksbank Lehrte
account N° 501 000
Zip code bank
BLZ 251 915 10

Vat. No.: DE813042185

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Editorial Calendar and Publishing Dates 2002

ZSW 1-2

Publishing Date: 13.02.2002
 Editorial Deadline: 02.01.2002
 Advertising Deadline: 28.01.2002

Follow-up reports on the
ISM - part I

Topic **Ingredients - very functional:**

Vitamins, Roughage, Extracts,
Enzymes, Hydrocolloides,
Emulsifying agents
Fairs: Biofach

plus:

Production: Chewing Gum,
Production and
Energy Saving

Focus: Paper Refinement

ZSW 3

Publishing Date: 13.03.2002
 Editorial Deadline: 01.02.2002
 Advertising Deadline: 25.02.2002

Follow-up reports on the
ISM - part II

Topic **Fats and Oils:**

Barrierfats, Coatings for Ice
cream, Special fats for Baking
goods, Fats for Light-
Products

plus:

Trends in
Confectionery, First look at
the INTERPACK, Pumps,
Sorting technology, Trends in
Packaging: Foils and more

Focus: Chocolate

ZSW 4

Publishing Date: 17.04.2002
 Editorial Deadline: 04.03.2002
 Advertising Deadline: 28.03.2002

Intersuc
INTERPACK - a preview

Topic **Packaging - Technology and Material:**

Robot Technology,
Tabular Bag Machinery,
Multipack-Technology,
Materials: the trends

plus:

The flowing of
Chocolate

Focus:
Wrapping Chocolate Bars

Production: Pralines

ZSW 5

Publishing Date: 22.05.2001
 Editorial Deadline: 08.04.2001
 Advertising Deadline: 03.05.2001

INTERPACK - a report I

Topic **Technology for Chocolate:**

Conches,
Moulding Machines, Shell
Manufacturing with Refrige-
ration, Cooling Tunnels,
Moulds for Chocolate,
Coating Machines,
Tempering Machines

plus:

Ingredients: Lecithin

Focus: High Speed Packaging
Machines for confectionery

ZSW 6

Publishing Date: 12.06.2002
 Editorial Deadline: 29.04.2002
 Advertising Deadline: 27.05.2002

INTERPACK - a report II

Topic **Starch and Milk Products:**

Special Starches, Milk
Powder, Dairy Products,
Cream Powder, Lactose,
Egg Products

plus:

Technology: Miniature
Cookies, Moulding Machines
for Sweets, Twin-screw-
kneader

Focus: Sensores

Editorial Calendar and Publishing Dates 2002

ZSW 7-8

Publishing Date: 14.08.2002
Editorial Deadline: 02.07.2002
Advertising Deadline: 30.07.2002

INTERPACK - a report III

Focus Quality Management and Hygienic:

Hygienic tests, Hygienic Design, Hygienic Materials, QM starts with the Technology, Hygienic Management, Transporting Conveyor Belts, Pest Control

plus: Washing Systems for Forms and Moulds, Aromas, Colouring agents, Mogul Technology, Cutting and Chopping

Focus: Silos and Big Bags

ZSW 9

Publishing Date: 11.09.2002
Editorial Deadline: 30.07.2002
Advertising Deadline: 27.08.2002

HI Europe - Intercool

Focus Technology - Measurement, Regulation, Controlling:

Technology for Measuring and Regulation, Opto Electronics, Controlling Technology, Electronic Noses

plus: Ice cream - chopped ingredients, Ice Cream Wafers, Worldtrends Ice Cream, Coating Machines for Ice Cream, Ice Cream - a scientific perspective, Fruits, Gumarabicum

ZSW 10

Publishing Date: 16.10.2002
Editorial Deadline: 04.09.2002
Advertising Deadline: 30.09.2002

Focus Raw Materials and Intermediate Products:

Intermediate Cocoa Products, Cocoa Powder, Nuts and their Products, Marcipan, Fillings

plus: Jellied Confectionery Production, Storage Technology, Kneading Technology for Cocoa Powder

Focus: Shell Manufacturing Plant

ZSW 11

Publishing Date: 13.11.2002
Editorial Deadline: 27.09.2002
Advertising Deadline: 28.10.2002

Focus Sugar, Sweets and Sugar Substitutes:

Liquid Sugar, Sugar Free Candies, Chocolate with Sugar Substitutes, Sweeteners - an Overview, Production of Jelly Beans

plus: Technology for Lollipops

Focus: Technology for Candies, Panning, Glossing Materials and Parting agents for Dragees

ZSW 12

Publishing Date: 18.12.2002
Editorial Deadline: 08.11.2002
Advertising Deadline: 02.12.2002

Focus Baking Goods and Long Shelf Baking Goods:

Special Flours, Producing Dough: Mixing, Kneading and Stiring, Technology for Cookies, Producing special wafers

plus: Moisture Measurement, Baking Ovens, Liqueur for Pralines

Focus: Conveyor systems

Messen/Fairs Deutschland/Germany 2002

27. – 30.01. ISM - Internationale Süßwaren-Messe, **Köln**
14. – 17.02. BioFach - Weltfachmesse für Naturkost und Naturwaren, **Nürnberg**
08. – 13.03. INTERNORGA - Internationale Fachmesse für Hotellerie, Gemeinschaftsverpflegung, Bäckereien und Konditoreien, **Hamburg**
23. – 27.04. METPACK - Internationale Fachmesse für Metallverpackungen, **Essen**
24. – 30.04. INTERPACK - Internationale Messe Verpackungsmaschinen, Packmittel, Süßwarenmaschinen, **Düsseldorf**
16. – 18.06. BÄKO BAYERN - Fachausstellung für das Bäcker- und Konditorenhandwerk, **Nürnberg**
06. – 09.10. InterCool - Internationale Fachmesse Tiefkühlkost, Speiseeis, Kältetechnik, **Düsseldorf**
21. – 23.09. Sachsen-Back - Fachmesse für das Bäcker- und Konditorenhandwerk, **Leipzig**
- 28.09. – 01.10. NORDBACK, **Hannover**
- in 10/02 südback, **Stuttgart**
06. – 09.10. INTERCOOL, **Düsseldorf**



Messen/Fairs weltweit/worldwide 2002

20. – 22.01. NASFT - International Fancy Food & Confection Show (Winter) **San Francisco (USA)**
24. – 27.01. FOOD FAIR - Internationale Nahrungsmittel- und Genussmesse, **Hongkong/SWG (China (VR))**
- 31.01. – 02.02. AWMA Expo 2002, **Dallas (USA)**
- in 2/02 BALTPIEK - Fachmesse für Bäckerei, Konditorei und Eisprodukte, **Danzig (Polen)**
04. – 08.02. PRODEXPO - Internationale Fachausstellung für Lebensmittel, **Moskau (Russland)**
13. – 15.02. Expo Golosinas - International Show of Delicacies, Snacks, Cookies, Candies, Chocolates and Similar, **Leon (Mexiko)**
24. – 27.02. MIA - Internationale Fachmesse für Lebensmittel, **Rimini (Italien)**
- 26.02. – 01.03. Ice-Cream and Refrigeration, **Moskau (Russland)**
- in 3/02 AHARA - Intern. Ausstellung Maschinen + Ausrüstungen für die Nahrungsmittelverarbeitung, **New Dehli (Indien)**
05. – 07.03. Food Tech - Messe für Lebensmitteltechnologien, -verarbeitung, -verpackung und -etikettierung, **Warschau (Polen)**
12. – 15.03. FOODEX, **Tokio (Japan)**

- in 4/02** InterFood/InterFoodTech/Pack St. Petersburg - Internationale Fachmesse für Lebensmittel und Getränke, Lebensmitteltechnik und Verpackungstechnologie und -materialien, **St. Petersburg (Russland)**
- 16. – 19.04.** BAKERY & PASTA - Internationale Fachausstellung für die Backindustrie, **Moskau (Russland)**
- 20. – 24.04.** INTERSUC - Internationale Fachmesse für Süß-, Schokoladen-, Dauer- und Feinbackwaren, **Paris (Frankreich)**
- 21. – 23.04.** SIAL Montreal, **Montreal (Kanada)**
- 15. – 17.05.** Bakery China - International Trade Fair for Bakery and Confectionery, **Shanghai (China VR)**
- 21. – 24.05.** WorldFoodTech - Internationale Messe für Lebensmittelverarbeitung, Verpackungsmaschinen und -material, **Moskau (Russland)**
- 22. – 24.05.** SIAL China, **Shanghai (China)**
- 04. – 06.06.** All Candy Expo, **Dallas (USA)**
- 30.06. – 02.07.** NASFT Int. Fancy Food and Confection Show, **New York (USA)**
- 17. – 19.09.** Health Ingredients - HI Europe, **Paris (Frankreich)**
- in 10/02** INTERSWEETS - Internationale Fachmesse, **Moskau (Russland)**
- 20. – 24.10.** SIAL, **Paris (Frankreich)**

- in 11/02** sladoSib - Internationale Ausstellung für Back- und Süßwaren, **Novosibirsk (Russland)**
- 03. – 07.11.** PACK-EXPO - the World of Packaging Technology, **Chicago (USA)**
- 03. – 07.11.** IEFP - Intern. Exposition for Food Processors, **Chicago (USA)**
- 18. – 22.11** EMBALLAGE - Internationale Verpackungsmesse, **Paris (Frankreich)**
- 18. – 22.11.** IPA/GIA - Intern. Fachmesse der Lebensmittel-Verfahrenstechnik und der Biotechnik, **Paris (Frankreich)**

Messen/Fairs worldwide 2003

- 05. – 07.01.** NASFT, **San Francisco (USA)**
- 26. – 29.01.** ISM, **Köln**
- 01. – 04.02.** InterKondiCa+Eis, **Wiesbaden**
- in 4/03** INTERSUC, **Paris (Frankreich)**
- 02. – 04.04.** SIAL Montreal, **Montreal (Kanada)**
- 08. – 12.04.** AnugaFoodTec, **Köln**
- 02. – 04.07.** SIAL Asia, **Singapur**
- in 8/03** SIAL Mercosur, **Buenos Aires (Argentinien)**
- 17. – 19.09.** FI Europe, **Paris (Frankreich)**
- 03. – 09.10.** IBA, **Düsseldorf**
- 08. – 10.10.** PowTech, **Nürnberg**
- in 10/03** FachPack, **N.N.**

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